

The GreenMOS[®] high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

The GreenMOS[®] Generic series is optimized for extreme switching performance to minimize switching loss. It is tailored for high power density applications to meet the highest efficiency standards.

GreenMOS[®]

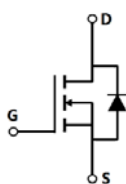


- Low $R_{DS(ON)}$ & FOM
- Extremely low switching loss
- Excellent stability and uniformity
- EMI and performance balanced

- LED lighting
- Charger
- Adapter
- TV power
- Telecom power
- Server power
- Solar/UPS

$V_{DS, min} @ T_{j(max)}$	700	V
$I_D, pulse$	13.5	A
$R_{DS(ON), max} @ V_{GS}=10V$	1.2	m
Q_g	7	nC

OSG07N65PF	TO220	OSG07N65P



at $T_j=25^{\circ}\text{C}$ unless otherwise noted

Drain-source voltage	V_{DS}	650	V
Gate-source voltage	V_{GS}	± 30	V

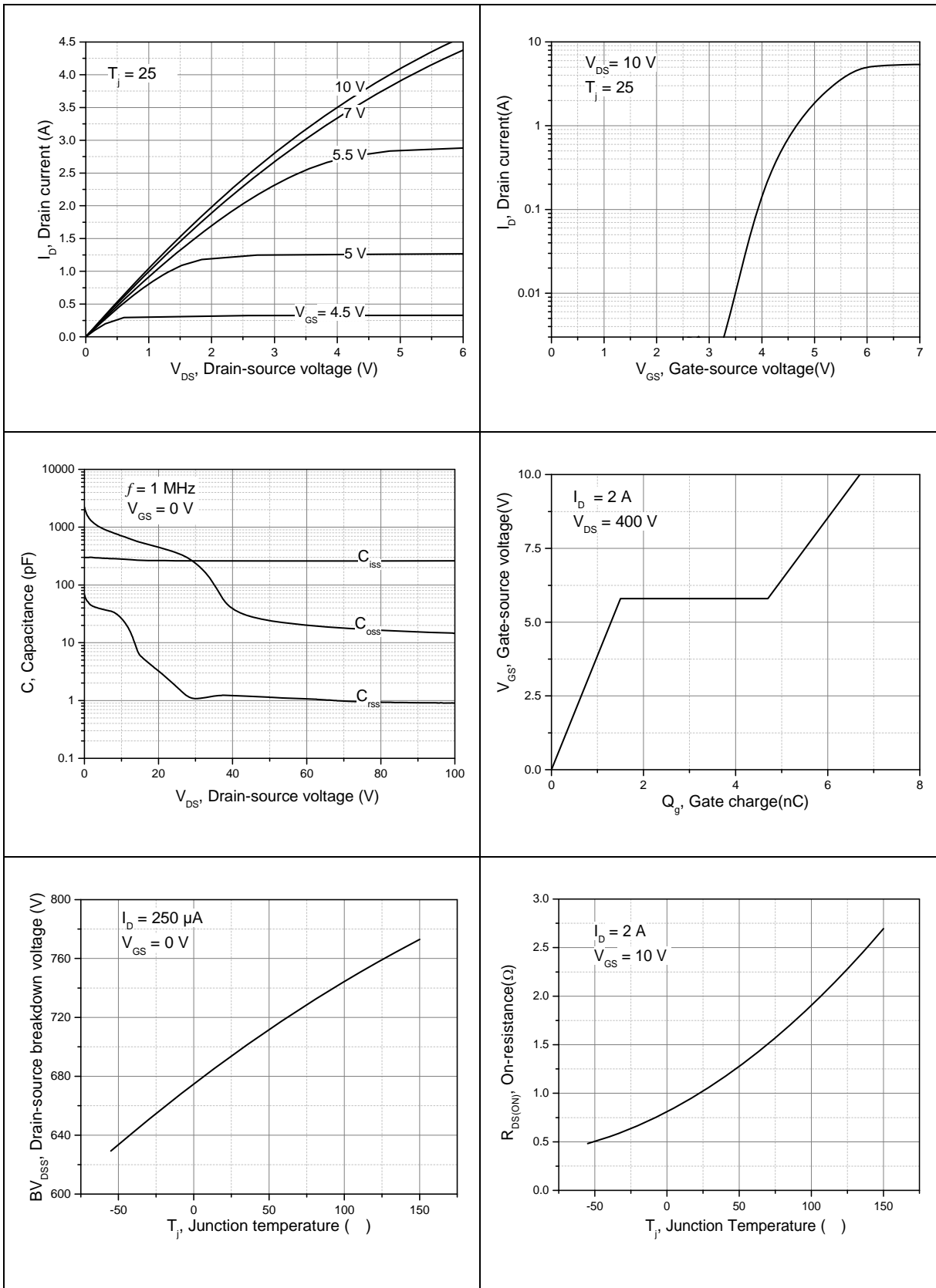
 Continuous drain current¹⁾, $T_C=25^{\circ}\text{C}$
 I_D

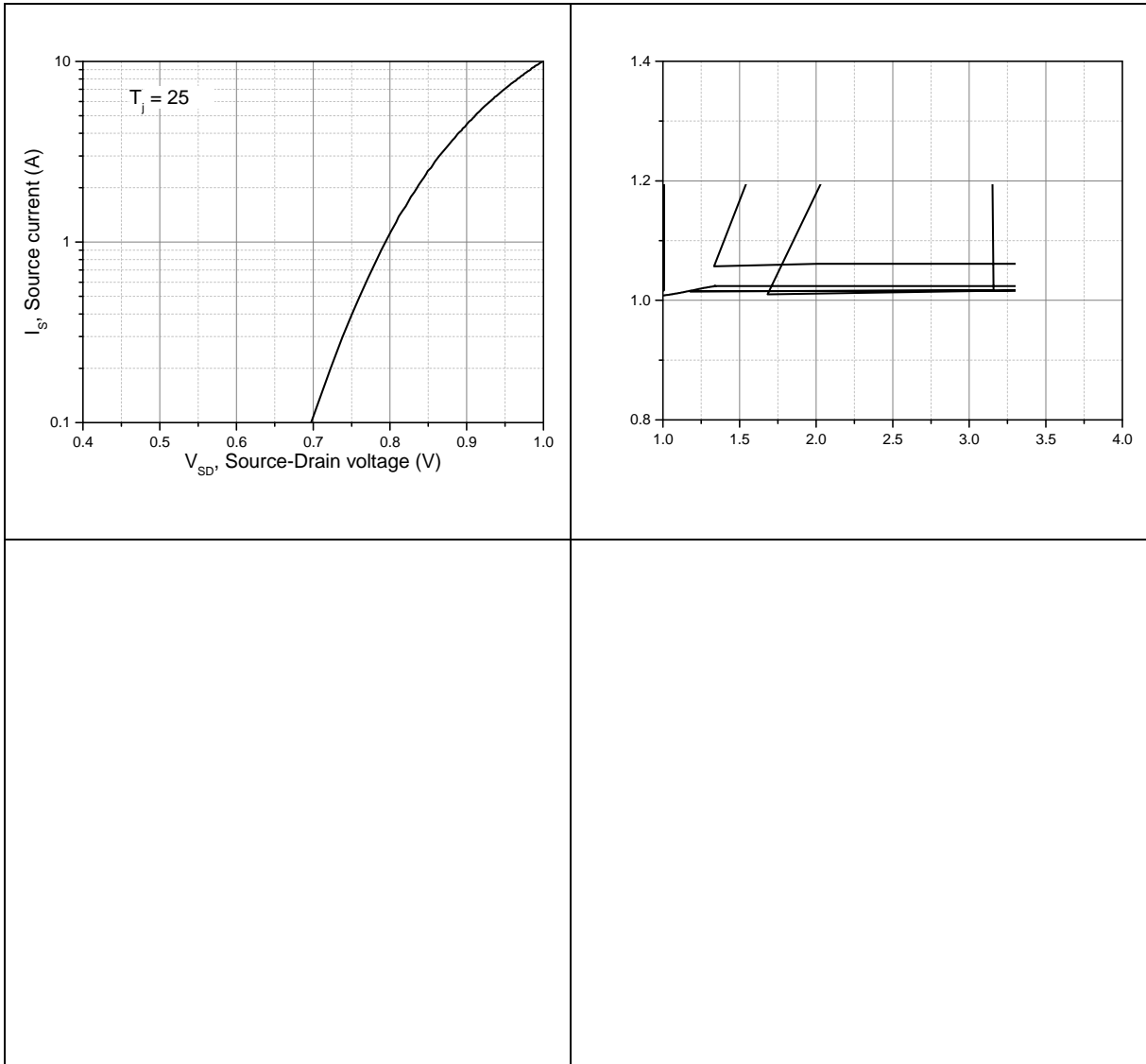
Input capacitance	C_{iss}	260.7	pF	$V_{GS}=0\text{ V},$ $V_{DS}=50\text{ V},$ $f=100\text{ KHz}$
Output capacitance	C_{oss}	24.1	pF	
Reverse transfer capacitance	C_{rss}	1.2	pF	
Turn-on delay time	$t_{d(on)}$	29.8	ns	$V_{GS}=10\text{ V},$ $V_{DS}=400\text{ V},$ $R_G=2\text{ }\Omega,$ $I_D=2\text{ A}$
Rise time	t_r	17.8	ns	
Turn-off delay time	$t_{d(off)}$	60.3	ns	
Fall time	t_f	14.9	ns	

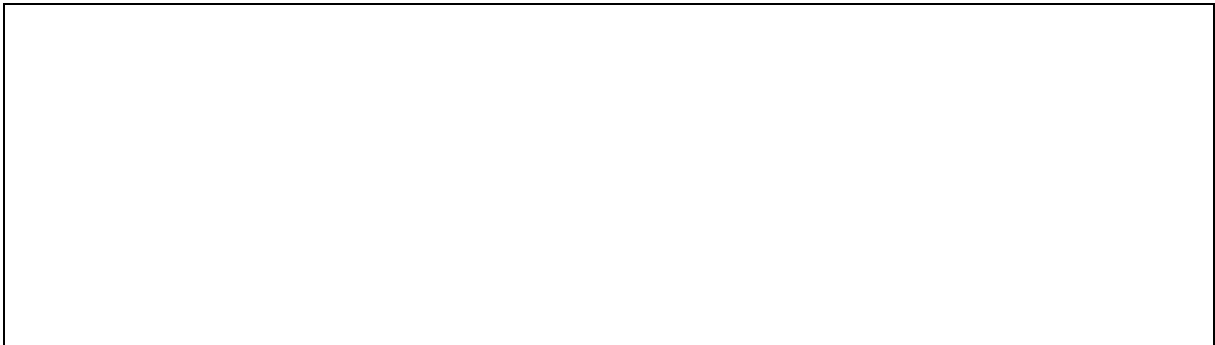
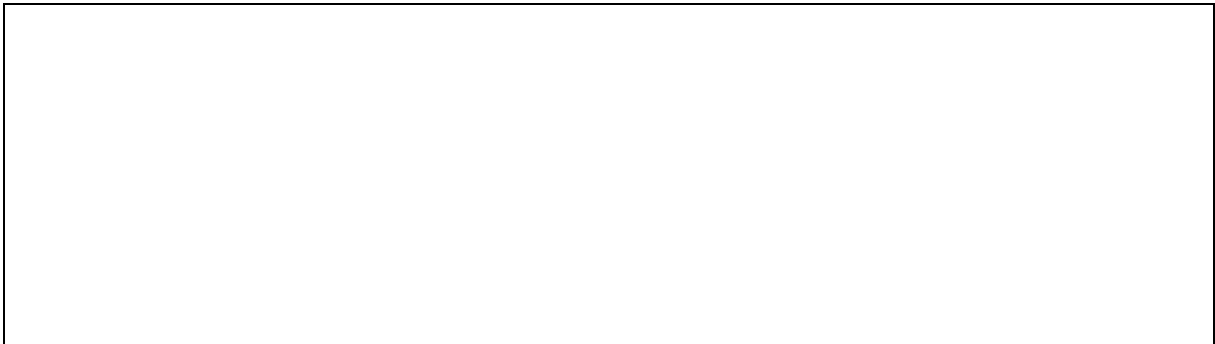
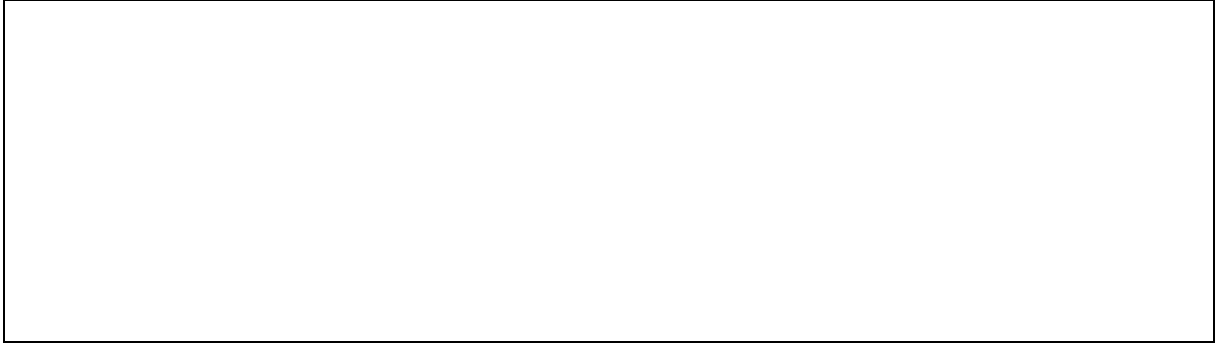
Total gate charge	Q_g	6.7	nC	$V_{GS}=10\text{ V},$ $V_{DS}=400\text{ V},$ $I_D=2\text{ A}$
Gate-source charge	Q_{gs}	1.5	nC	
Gate-drain charge	Q_{gd}	3.2	nC	
Gate plateau voltage	$V_{plateau}$	5.8	V	

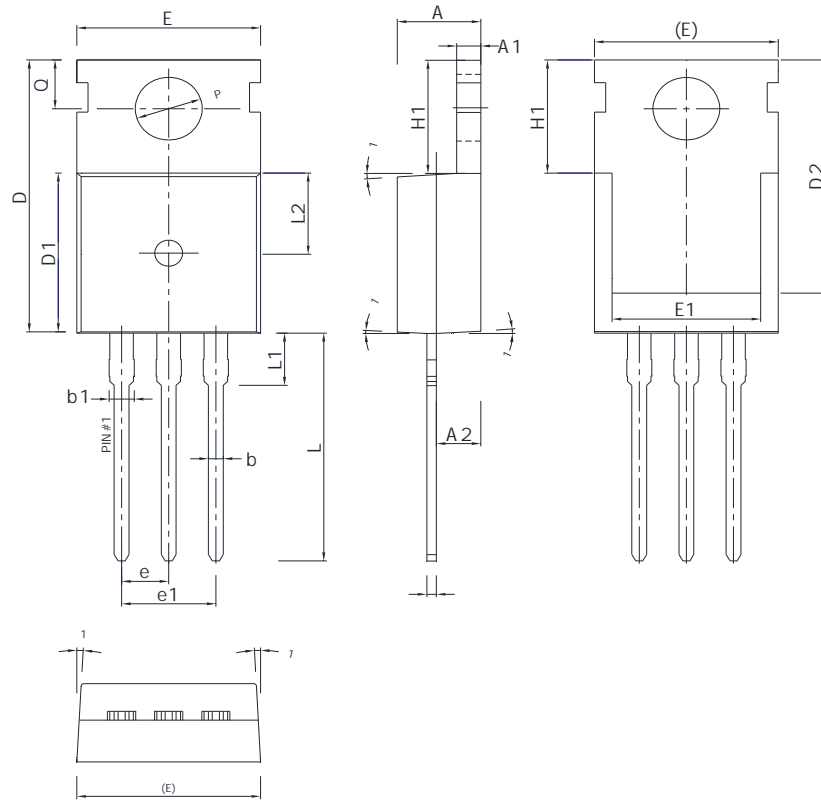
Diode forward voltage	V_{SD}	1.3	V	$I_S=4.5\text{ A},$ $V_{GS}=0\text{ V}$
Reverse recovery time	t_{rr}	130	ns	$V_R=400\text{ V},$ $I_S=2\text{ A},$ $di/dt=100\text{ A}/\mu\text{s}$
Reverse recovery charge	Q_{rr}	0.92	μC	
Peak reverse recovery current	I_{rrm}	14.7	A	

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) P_d is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of R_{JA} is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with $T_a=25\text{ }^\circ\text{C}$.
- 5) $V_{DD}=100\text{ V}, V_{GS}=10\text{ V}, L=60\text{ mH}$, starting $T_j=25\text{ }^\circ\text{C}$.









Symbol	mm		
	Min	Nom	Max
A	4.40	4.50	4.60
A1	1.27	1.30	1.33
A2	2.30	2.40	2.50
b	0.70	-	0.90
b1	1.27	-	1.40
c	0.45	0.50	0.60
D	15.30	15.70	16.10
D1	9.10	9.20	9.30
D2	13.10	-	13.70
E	9.70	9.90	10.20
E1	7.80	8.00	8.20
e	2.54 BSC		
e1	5.08 BSC		
H1	6.30	6.50	6.70
L	12.78	13.08	13.38
L1	-	-	3.50
L2	4.60 REF		
P	3.55	3.60	3.65
Q	2.73	-	2.87
1	1°	3°	5°

Version 1: TO220-J outline dimension

TO220-J	50	20	1000	5	5000

OSG07N65PF	TO220	yes	yes	yes

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